#### **TOSHIBA Photocoupler Photorelay**

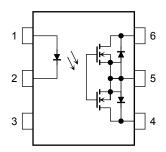
## **TLP3100**

# Measurement Equipment FA (Factory Automation) Power Line Control

The Toshiba TLP3100 consists of an aluminum gallium arsenide infrared emitting diode optically coupled to a photo-MOSFET in a SOP, which is suitable for surface-mount assembly. The TLP3100 features high ON-state current and low ON-state resistance, hence the TLP3100 is suitable to control a power line.

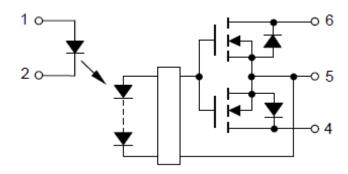
- 6-pin SOP (2.54SOP6): 2.1 mm high, 2.54 mm pitch
- Normally opened (form A) device
- Peak OFF-state voltage: 20 V (min)
- Trigger LED current: 3 mA (max)
- ON-state current: 2.5 A (max) (Ta=50°C)
- ON-state resistance:  $0.02 \Omega$  (typ),  $0.05 \Omega$  (max)
- Capacitance: 1000 pF (typ)
- OFF-state current: 10 nA (max)
- Isolation voltage: 1500 V<sub>rms</sub> (min)

## Pin Configuration (top view)

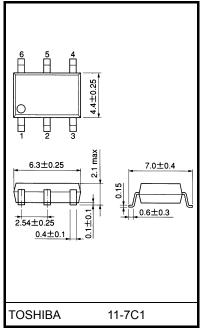


- 1: Anode
- 2: Cathode
- 3: N.C.
- 4: Drain D1
- 5: Source
- 6: Drain D2

#### **Schematic**



Unit: mm



Weight: 0.13 g (typ.)

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit		
LED	Forward current		lF	30	mA	
	Forward current derating (Ta ≥ 25°C)		ΔI <sub>F</sub> /°C	-0.3	mA/°C	
LLD	Reverse voltage		V <sub>R</sub>	5	V	
	Junction temperature		Tj	125	°C	
	Off-state out	put terminal voltage	V <sub>OFF</sub>	20	V	
	On-state current	A connection		2.5		
		B connection	I <sub>ON</sub>	2.5	Α	
Detector		C connection		5.0		
Detector	Forward current derating (Ta ≥ 50°C)	A connection		-33.3		
		B connection	Δl <sub>ON</sub> /°C	-33.3	mA/°C	
		C connection		-66.7		
	Junction tem	perature	Tj	125	°C	
Storage temperature		T <sub>stg</sub>	-55 to 125	°C		
Operating temperature		T <sub>opr</sub>	-40 to 85	°C		
Lead soldering temperature (10 s)			T <sub>sol</sub>	260	°C	
Isolation	Isolation voltage (AC, 1 min, R.H. $\leq$ 60%) (Note 1)			1500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two-terminal device: Pins 1 and, 2 shorted together, and pins 3 and 4 shorted together.

#### Caution

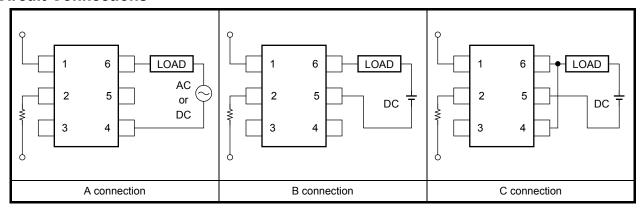
This device is sensitive to electrostatic discharge. When using this device, please ensure that all tools and equipment are earthed.

#### **Recommended Operating Conditions**

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	$V_{DD}$	_	_	20	V
Forward current	ΙF	5	10	20	mA
Operating temperature	T <sub>opr</sub>	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

#### **Circuit Connections**



## **Individual Electrical Characteristics (Ta = 25°C)**

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward current	V <sub>F</sub>	I <sub>F</sub> = 10 mA	1.18	1.33	1.48	V
LED	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	μА
	Capacitance	C <sub>T</sub>	V = 0, f = 1 MHz		70		pF
Detector	OFF-state current	I <sub>OFF</sub>	V <sub>OFF</sub> = 20 V	_	_	10	nA
Dete	Capacitance	C <sub>OFF</sub>	V = 0, f = 1 MHz		1000		pF

## **Coupled Electrical Characteristics (Ta = 25°C)**

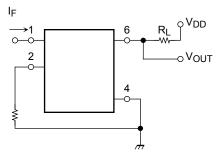
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current		I <sub>FT</sub>	I <sub>ON</sub> = 100 mA	_	_	3	mA
Return LED current		I <sub>FC</sub>	I <sub>OFF</sub> = 10 μA	0.1	_	_	mA
	A connection		I <sub>ON</sub> = 2.0 A, I <sub>F</sub> = 5 mA, t<1s	_	0.02	0.05	
On-state resistance	B connection	R <sub>ON</sub>	I <sub>ON</sub> = 2.0 A, I <sub>F</sub> = 5 mA, t<1s	_	0.01	0.025	Ω
	C connection		I <sub>ON</sub> = 4.0 A, I <sub>F</sub> = 5 mA, t<1s	_	0.005	_	

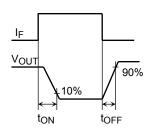
## **Isolation Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	V <sub>S</sub> = 0 V, f = 1 MHz	_	8.0	_	pF
Isolation resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H. ≤ 60%	$5 \times 10^{10}$	10 <sup>14</sup>	_	Ω
		AC, 1 min	1500	_	_	- Vrms
Isolation voltage		AC, 1 s (in oil)	_	3000	_	
		DC, 1 min (in oil)	_	3000		Vdc

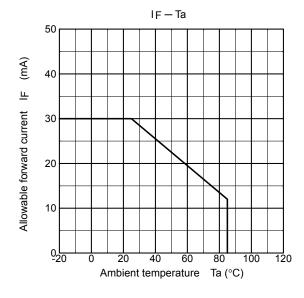
## Switching Characteristics (Ta = 25°C)

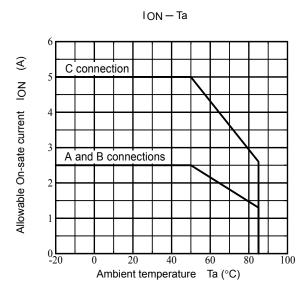
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-ON time toN		$R_L = 200 \Omega$	_	1.5	5.0	ms
Turn-OFF time	t <sub>OFF</sub>	$V_{DD} = 10 \text{ V}, I_F = 5 \text{ mA}$ (Note 2)	_	0.1	1.0	1115

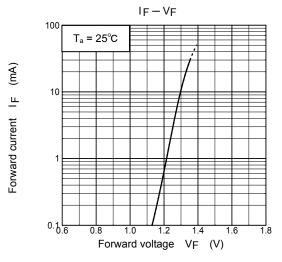


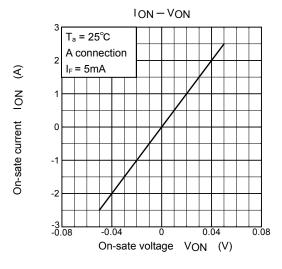


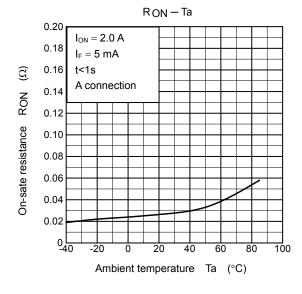
Note 2: Switching time test circuit

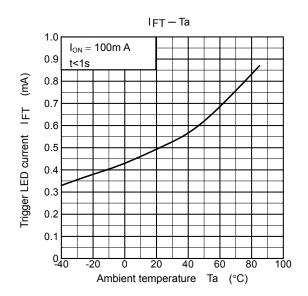






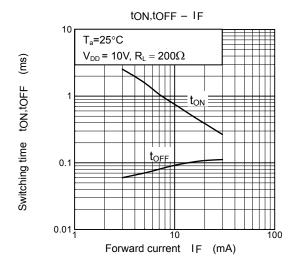


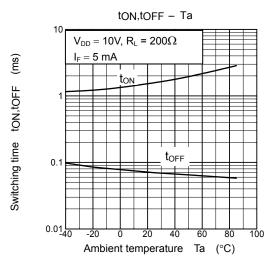


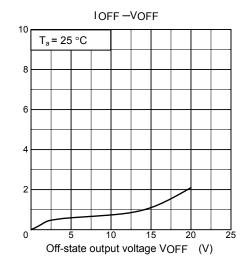


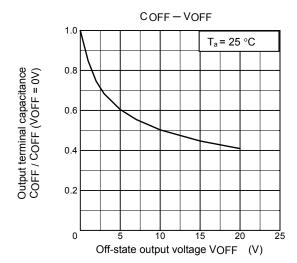
(nA)

Off-state current IOFF









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